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Smart Infrastructure around MTCA Crates

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Increasing power dissipation and computational demands have made the supporting infrastructure of MicroTCA systems a key factor for reliable and efficient operation. System architects must address challenges in thermal management, power distribution, monitoring, and electromagnetic compatibility (EMC) to maintain stable performance. A controlled thermal environment—achieved through air-to-water heat exchangers—is essential for ensuring the long-term integrity of sensitive electronics. Intelligent power distribution units (IP-DUs) further enhance reliability by enabling remote sensor monitoring, fault detection, and targeted power cycling when required. In addition, robust EMC shielding of the enclosures that host the MTCA crates is critical to minimizing interference and preserving signal integrity in high-density environments. This presentation explores how integrating such smart infrastructure components around MTCA crates enhances operational stability, supports predictive maintenance, and enables scalable, future-proof system designs.

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